

To our customers,

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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EOL announced Product

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SWITCHING

N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3900 is N-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3900-ZP	TO-263 (MP-25ZP)

FEATURES

- Super low on-state resistance

$R_{DS(on)1} = 8.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 41 \text{ A)}$

$R_{DS(on)2} = 10 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 41 \text{ A)}$

- Low C_{iss} : $C_{iss} = 3500 \text{ pF TYP.}$
- Built-in gate protection diode

(TO-263)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	60	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC) ($T_C = 25^\circ\text{C}$)	$I_{D(DC)}$	± 82	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 246	A
Total Power Dissipation ($T_C = 25^\circ\text{C}$)	P_{T1}	104	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_{T2}	1.5	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Single Avalanche Energy ^{Note2}	E_{AS}	141	mJ
Repetitive Avalanche Current ^{Note3}	I_{AR}	37.5	A
Repetitive Avalanche Energy ^{Note3}	E_{AR}	141	mJ

Notes 1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

2. Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = 30 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$, $L = 100 \mu\text{H}$

3. $R_G = 25 \Omega$, $T_{ch(peak)} \leq 150^\circ\text{C}$

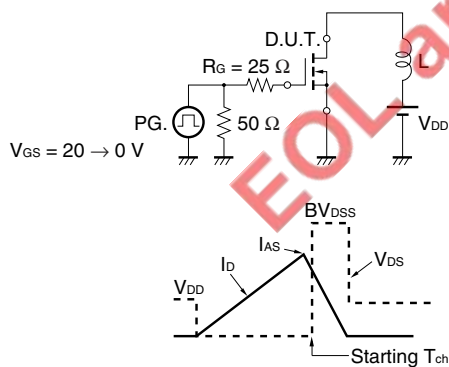
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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

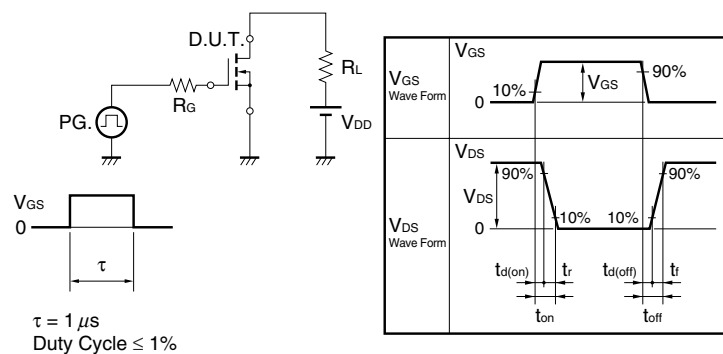
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance ^{Note}	y _{fs}	V _{DS} = 10 V, I _D = 41 A	28.1	56		S
Drain to Source On-state Resistance ^{Note}	R _{DS(on)1}	V _{GS} = 10 V, I _D = 41 A		6.3	8.0	mΩ
	R _{DS(on)2}	V _{GS} = 4.5 V, I _D = 41 A		7.4	10	mΩ
Input Capacitance	C _{iss}	V _{DS} = 10 V		3500		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		660		pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		240		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 41 A		18		ns
Rise Time	t _r	V _{GS} = 10 V		11		ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		62		ns
Fall Time	t _f			5.5		ns
Total Gate Charge	Q _G	V _{DD} = 48 V		65.5		nC
Gate to Source Charge	Q _{GS}	V _{GS} = 10 V		11.5		nC
Gate to Drain Charge	Q _{GD}	I _D = 82 A		16.5		nC
Body Diode Forward Voltage ^{Note}	V _{F(S-D)}	I _F = 82 A, V _{GS} = 0 V		0.95	1.5	V
Reverse Recovery Time	t _{rr}	I _F = 82 A, V _{GS} = 0 V		41		ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100 A/μs		61		nC

Note Pulsed

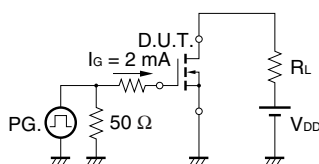
TEST CIRCUIT 1 AVALANCHE CAPABILITY



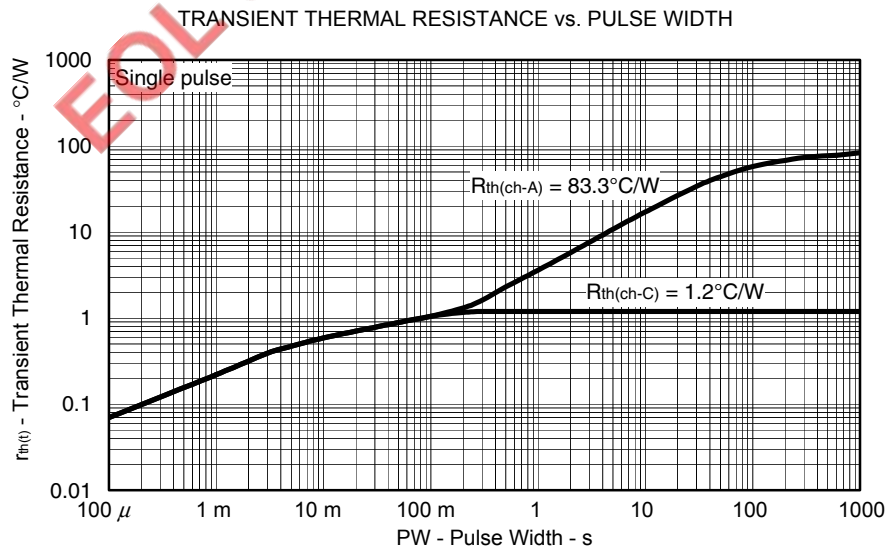
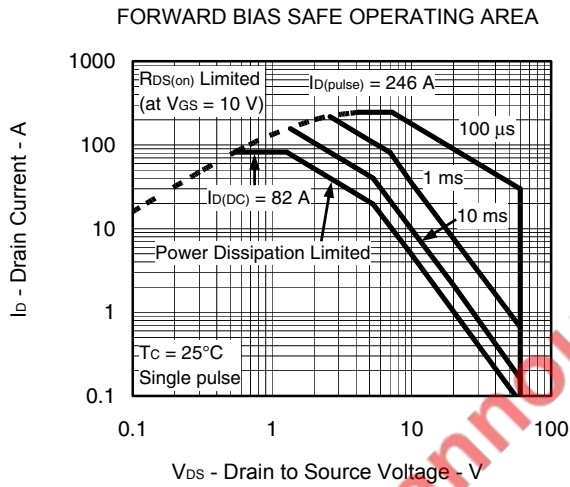
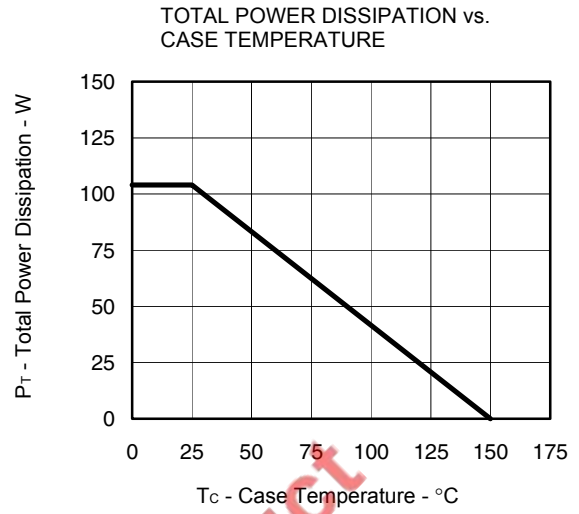
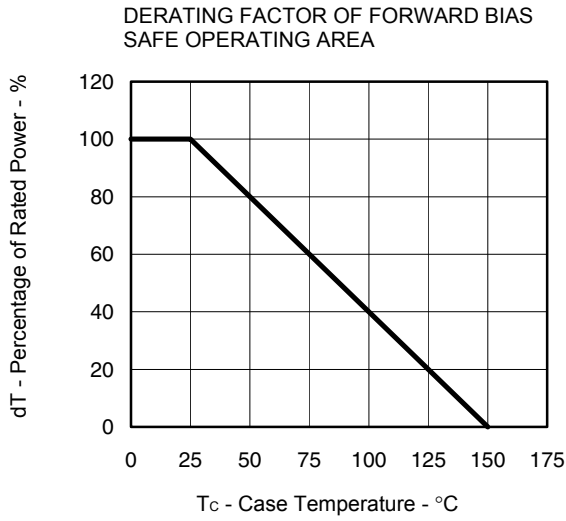
TEST CIRCUIT 2 SWITCHING TIME



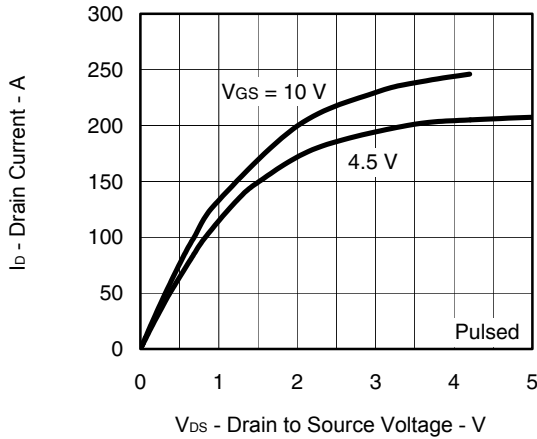
TEST CIRCUIT 3 GATE CHARGE



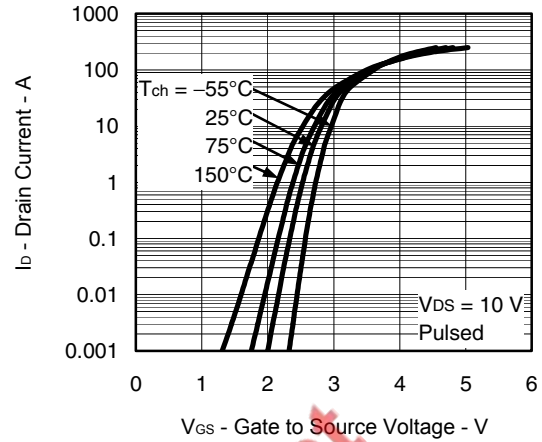
TYPICAL CHARACTERISTICS (T_A = 25°C)



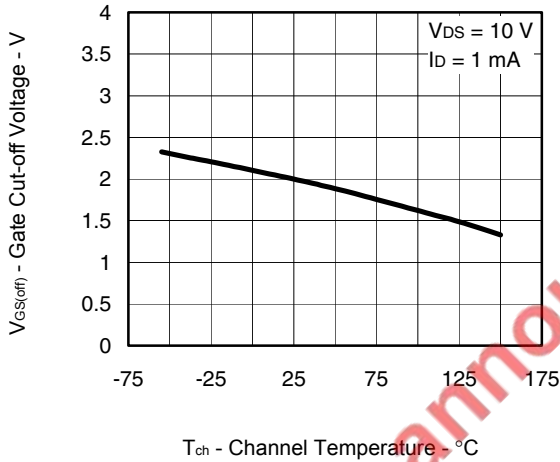
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



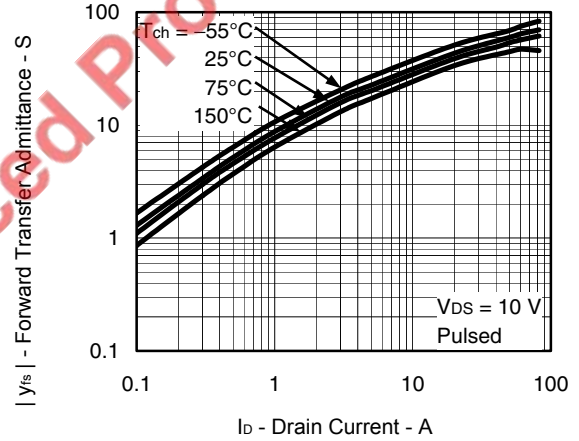
FORWARD TRANSFER CHARACTERISTICS



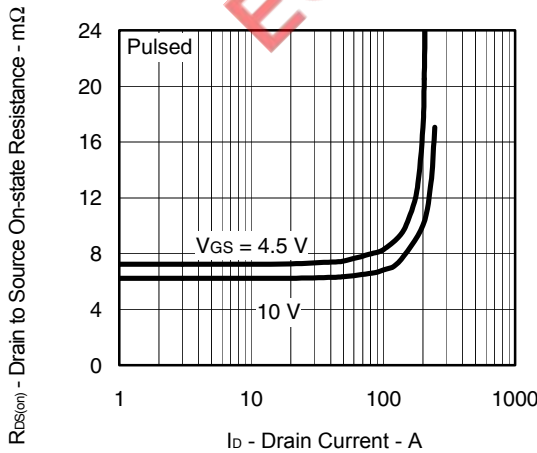
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



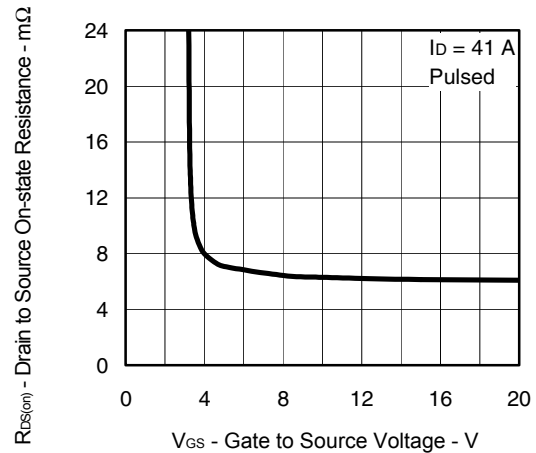
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



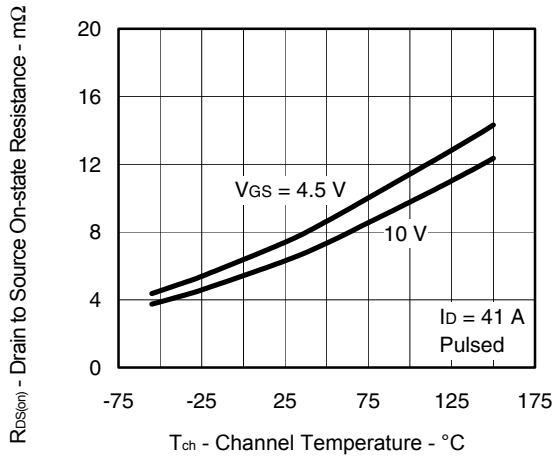
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



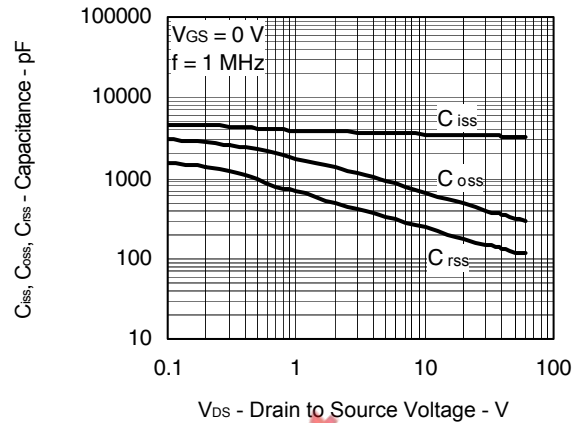
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



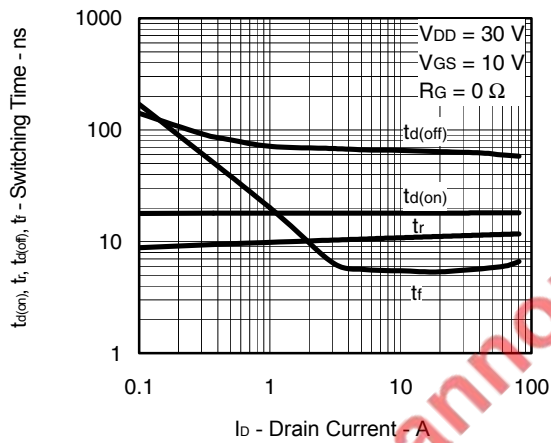
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



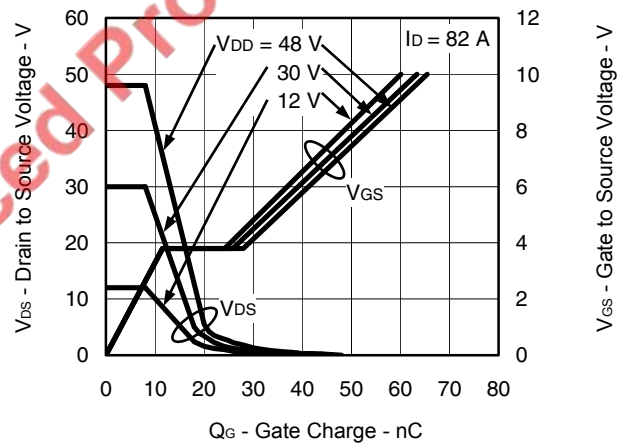
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



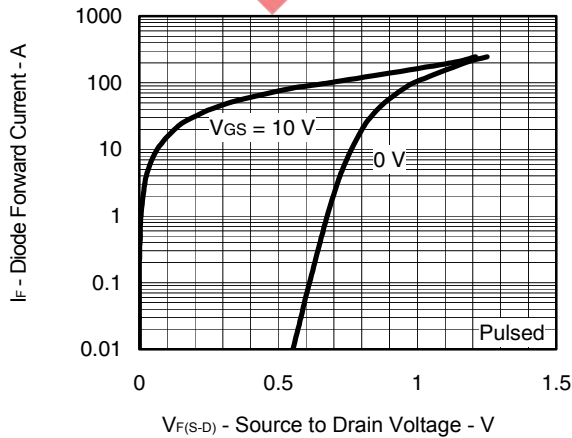
SWITCHING CHARACTERISTICS



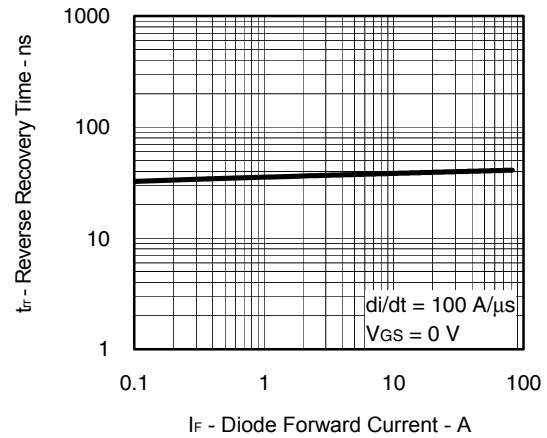
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



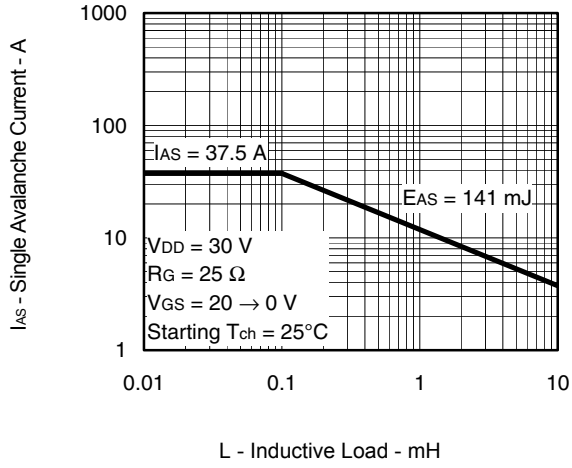
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



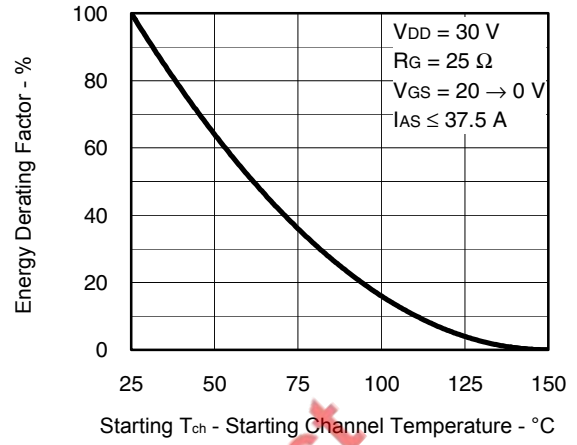
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



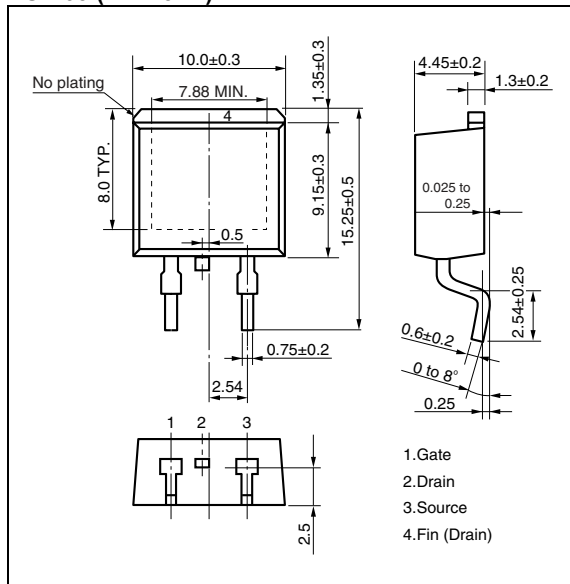
SINGLE AVALANCHE ENERGY DERATING FACTOR



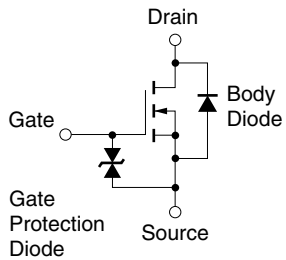
EOL announced Product

PACKAGE DRAWING (Unit: mm)

TO-263 (MP-25ZP)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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